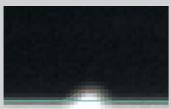


SensoPart has expanded its range of vision sensors with the VISOR® Solar in order to combat rising cost pressure in the production of solar cells. The compact sensor detects the position damage that could lead to breakage during the print process, and any damage to wafers and cells. It allows robots to pick up and lay down wafers accurately. Wafers and solar cells with fine breakouts can be directly rejected during this step, before they can completely break up and damage other material.

These sensors can also be integrated in existing lines – as easily as a light barrier. Before a cell is printed, the sensor checks it for preventing costly machine breakdowns.



The VISOR® Solar sensor operates accurately and reliably even in fast-cycle



The VISOR® Solar sensor measures every wafer or cell and thus detects even minimal edge breakouts.

HIGHLIGHTS OF VISOR® SOLAR SENSOR

- Simple integration
- Precise position detection down to \pm 50 μm
- Edge defects can be detected up to a depth of 0.50 mm
- Differentiation between C-shaped and V-shaped edge defects
- Detection of holes
- Transport belts can be masked via software
- Short cycle time from 60 ms
- Reliable operation, even in daylight
- No backlight necessary
- Low space requirement: operating distance from 360 mm

Vision Sensors and Systems – Produc	ct Overview			
	Firmware Option	Focal length	Integrated illumination	Page
VISOR® Solar sensor				
V10-SO-S1-xxx	Standard	6	White LEDs	68
V10-SO-A1-xxx	Advanced	6	White or infrared LEDs	70
V10-SO-A1-xxx	Advanced	12	White or infrared LEDs	72

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Standard vision sensor for wafer and cell inpection, 6 mm



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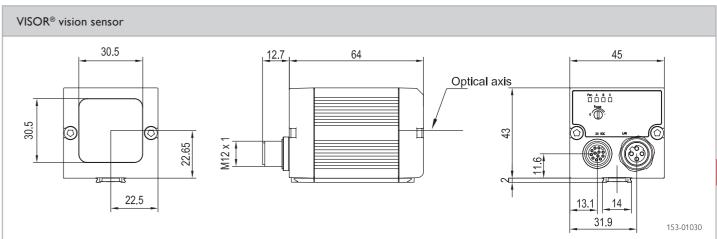
PRODUCT HIGHLIGHTS

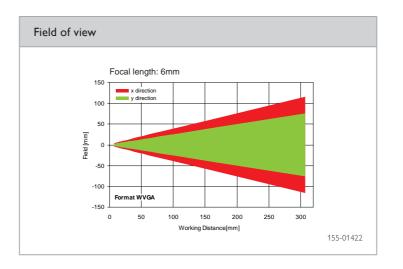
- Automatic detection of wafer and cell geometry
- Suitable for frontlit and backlit applications
- Simple sensor optimisation regarding evaluation speed and test precision (sub-pixel process)
- Detection of holes/cracks and breakouts
- Distortion correction

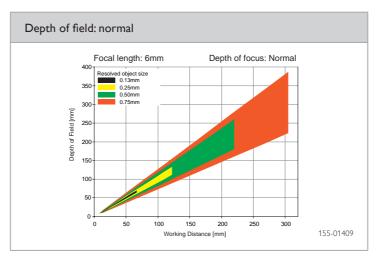
Optical data		Functions	
Resolution CMOS	736 x 480 pixels 1/3". monochrome	Number of jobs / detectors Detectors	2 / 32 Wafers, contrast, brightness, grey leve
Integrated lens, focal length Adjustment range	6 mm, adjustable focal position 6 mm to infinity	Properties	Wafers: localisation and examination of wafers Grey threshold, brightness:
Integrated illumination Minimum field of view, X × Y	White LEDs 5 x 4 mm ²		evaluation of brightness Contrast: evaluation of contrast
		Typical cycle times	Typ. 100 ms wafer Typ. 2 ms brightness Typ. 2 ms contrast Typ. 2 ms grey threshold
Electrical data		Mechanical data	
Operating voltage, +U _B	18 26.4 V DC ¹	Dimensions	65 × 45 × 45 mm³ (without plug)
Current consumption (without illumination and I/O)	≤120 mA	Enclosure rating Material, housing	IP 67 Aluminium, plastic
Current consumption (without I/O)	≤ 200 mA	Material, front screen	Plastic
Protective circuits	Reverse-polarity protection, U _B / short-circuit protection of all outputs	Ambient temperature: operation Ambient temperature: storage	0 +50 °C² -20 +60 °C²
Readiness delay	Ca. 13 s after Power on		Ca. 160 g
Outputs	PNP / NPN (switchable)		Supply and I/O M12, 12-pin
Max. output current (per output)	50 mA, 100 mA (pin 12)	Tidg connections	Ethernet M12, 4-pin
Inputs	PNP/NPN High $> U_B - 1 \text{ V, Low} < 3 \text{ V}$	Vibration and impact resistance	EN 60947-5-2
Input resistance	> 20 kOhm		
Encoder input	High > 4 V		
Interfaces: VISOR® V10-SO-Standard	Ethernet (LAN), EtherNet/IP		
Inputs/outputs	2 inputs, 4 outputs, 2 selectable inputs/outputs		

 $^{^{1}}$ Max. ripple \leq 5 V_{ss} 2 80 % air humidity, non-condensing

Illumination	Depth of field	Part number	Article number
White	Normal	V10-SO-S1-W6	535-91049







Connection cables	From Page 670
Illumination	From Page 663
Brackets	From Page 642
Interface accessories	From Page 674

Advanced vision sensor for wafer and cell inspection, 6 mm

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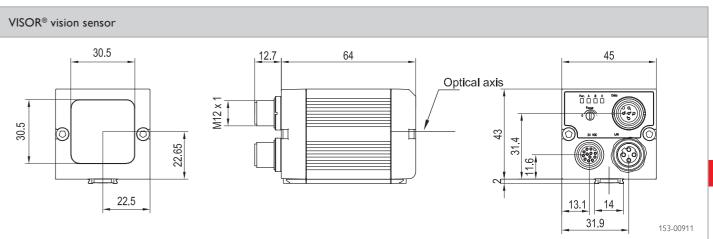
PRODUCT HIGHLIGHTS

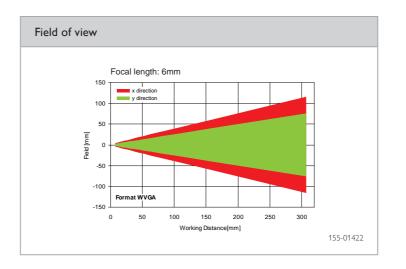
- Automatic detection of wafer and cell geometry
- Suitable for frontlit and backlit applications
- Simple sensor optimisation regarding evaluation speed and test precision (sub-pixel process)
- Detection of holes/cracks and breakouts
- Distortion correction
- Examination and position detection of busbars

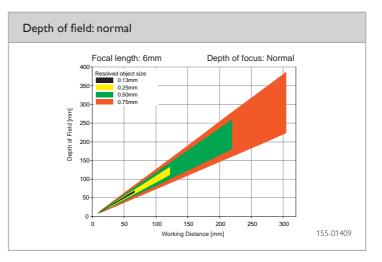
Optical data		Functions	
Resolution	736 x 480 pixels	Number of jobs / detectors	n / n
CMOS	1/3", monochrome	Detectors	Wafers, busbars, pattern comparison
Integrated lens, focal length	6 mm, adjustable focal position	T	contrast, brightness, grey level
Adjustment range	6 mm to infinity	Properties	Position tracking
Integrated illumination	White, infrared LEDs		Wafers incl. busbars: localisation of
Minimum field of view, X x Y	5 × 4 mm ²		wafers or busbars and examination wafers Pattern comparison: teach-in and detection of patterns Grey threshold, brightness: evaluatio of brightness Contrast: evaluation of contrast
		Typical cycle times	Typ. 100 ms wafers Typ. 20 ms pattern comparison Typ. 2 ms brightness Typ. 2 ms contrast Typ. 2 ms grey threshold
Electrical data		Mechanical data	
Operating voltage, +U _B	18 26.4 V DC ¹	Dimensions	65 x 45 x 45 mm³ (without plug)
Current consumption	≤ 120 mA	Enclosure rating	IP 67
(without illumination and I/O)		Material, housing	Aluminium, plastic
Current consumption (without I/O)	≤ 200 mA	Material, front screen	Plastic
Protective circuits	Reverse-polarity protection, U _B /	Ambient temperature: operation	0 +50 °C ²
D 1: 1.1	short-circuit protection of all outputs	Ambient temperature: storage	-20 +60 °C²
Readiness delay	Ca. 13 s after Power on	Weight	Ca. 160 g
Outputs	PNP / NPN (switchable)	— Plug connections	Supply and I/O M12, 12-pin
Max. output current (per output)	50 mA, 100 mA (pin 12) PNP/NPN High > U₀-1 V, Low < 3 V	-	Ethernet M12, 4-pin Data M12, 5-pin
Inputs	> 20 kOhm	Vib.astica.cadiascast.cadiata	Data 1912, 5-pin FN 60947-5-2
Input resistance		Vibration and impact resistance	EIN 00747-3-2
Encoder input Interfaces: VISOR® V10-SO-Advanced	High > 4 V Ethernet (LAN), RS422, EtherNet/IP		
Inputs/outputs	2 inputs, 4 outputs, 4 selectable inputs/outputs		

 $^{^{1}}$ Max, ripple < 5 V_{ss} 2 80 % air humidity, non-condensing

Illumination	Depth of field	Part number	Article number
White	Normal	V10-SO-A1-W6	535-91051
Infrared	Normal	V10-SO-A1-I6	535-91053







Accessories		
Connection cables	From Page 670	
Illumination	From Page 663	
Brackets	From Page 642	
Interface accessories	From Page 674	

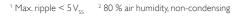
Advanced vision sensor for wafer and cell inspection, 12 mm

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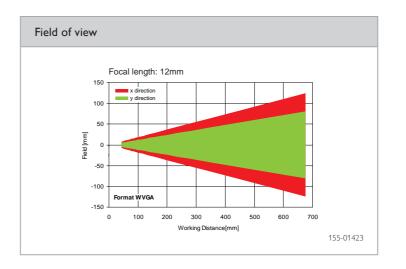
PRODUCT HIGHLIGHTS

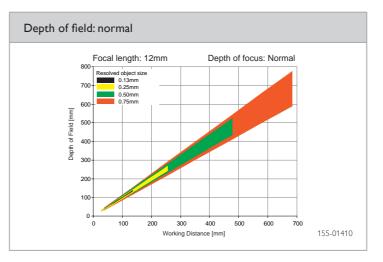
- Automatic detection of wafer and cell geometry
- Suitable for frontlit and backlit applications
- Simple sensor optimisation regarding evaluation speed and test precision (sub-pixel process)
- Detection of holes/cracks and breakouts
- Distortion correction
- Examination and position detection of busbars

Optical data		Functions	
Resolution	736 x 480 pixels	Number of jobs / detectors	n/n
CMOS	1/3", monochrome	Detectors	Wafers, busbars, pattern comparisor
Integrated lens, focal length	12 mm, adjustable focal position		contrast, brightness, grey level
Adjustment range	30 mm to infinity	Properties	Position tracking
Integrated illumination	White, infrared LEDs		Wafers incl. busbars:
Minimum field of view, X x Y	8 x 6 mm ²		localisation of wafers or busbars an examination of wafers Pattern comparison: teach-in and detection of patterns Grey threshold, brightness: evaluation of brightness Contrast: evaluation of contrast
		Typical cycle times	Typ. 100 ms wafer Typ. 20 ms pattern comparison Typ. 2 ms brightness Typ. 2 ms contrast Typ. 2 ms grey threshold
Electrical data		Mechanical data	
Operating voltage, +U _B	18 26.4 V DC ¹	Dimensions	65 x 45 x 45 mm³ (without plug)
Current consumption	≤ 120 mA	Enclosure rating	IP 67
(without illumination and I/O)		Material, housing	Aluminium, plastic
Current consumption (without I/O)	≤ 200 mA	Material, front screen	Plastic
Protective circuits	Reverse-polarity protection, U _B /	Ambient temperature: operation	0 +50 °C²
	short-circuit protection of all outputs	Ambient temperature: storage	-20 +60 °C²
Readiness delay	Ca. 13 s after Power on		Ca. 160 g
Outputs	PNP / NPN (switchable)	Plug connections Supply	Supply and I/O M12, 12-pin
Max. output current (per output)	50 mA, 100 mA (pin 12)		Ethernet M12, 4-pin
Inputs	PNP/NPN High > U _B -1 V, Low < 3 V	\\ \frac{1}{2} \cdot \cd	Data M12, 5-pin
Input resistance	> 20 kOhm	Vibration and impact resistance	EN 60947-5-2
Encoder input Interfaces:VISOR® V10-SO-Advanced	High > 4 V Ethernet (LAN), RS422, EtherNet/IP		
Inputs/outputs	2 inputs, 4 outputs, 4 selectable inputs/outputs		



Illumination	Depth of field	Part number	Article number
White	Normal	V10-SO-A1-W12	535-91052
Infrared	Normal	V10-SO-A1-I12	535-91054





Accessories		
Connection cables	From Page 670	
Illumination	From Page 663	
Brackets	From Page 642	
Interface accessories	From Page 674	